

# **UTC** UNISONIC TECHNOLOGIES CO., LTD

## 3N50Z

Preliminary

## 3A, 500V **N-CHANNEL POWER MOSFET**

#### DESCRIPTION

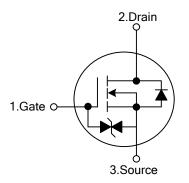
The UTC 3N50Z is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC 3N50Z is generally applied in high efficiency switch mode power supplies, active power factor correction and electronic lamp ballasts based on half bridge topology.

#### **FEATURES**

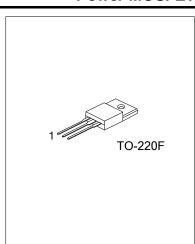
- \* R<sub>DS(ON)</sub>=3.2Ω @ V<sub>GS</sub>=10V
- \* High Switching Speed
- \* 100% Avalanche Tested

#### **SYMBOL**



### **ORDERING INFORMATION**

Ordering Number		Daakaga	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
3N50ZL-TF3-T	3N50ZG-TF3-T	TO-220F	G	D	S	Tube	
Note: Pin Assignment: G: G	ate D: Drain S: Source						
3N50ZL- <u>TF3</u> -T (1)Packing Type (2)Package Type		(1) T: Tube (2) TF3: TO-22( (3) G: Halogen I		ead Free			



#### ABSOLUTE MAXIMUM RATINGS (T<sub>c</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V <sub>DSS</sub>	500	V
Gate-Source Voltage		V <sub>GSS</sub>	±30	V
Drain Current	Continuous (T <sub>C</sub> =25°C)	ID	3 (Note 5)	А
	Pulsed (Note 2)	I <sub>DM</sub>	12 (Note 5)	А
Avalanche Current (Note 2)		I <sub>AR</sub>	3	А
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	200	mJ
	Repetitive (Note 4)	E <sub>AR</sub>	6.2	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation (T <sub>c</sub> =25°C)		D	25	W
Derate above 25°C		P <sub>D</sub>	0.2	W/°C
Junction Temperature		TJ	+150	°C
Storage Temperature		T <sub>STG</sub>	-55~+150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature

3. L = 40mH,  $I_{AS}$  = 3A,  $V_{DD}$  = 50V,  $R_G$  = 25 $\Omega$ , Starting  $T_J$  = 25 $^{\circ}$ C

4.  $I_{SD} \leq 3A$ , di/dt  $\leq 200A/\mu s$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$ 

5. Drain current limited by maximum junction temperature

#### THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	$\theta_{JA}$	62.5	°C/W
Junction to Case	θ <sub>JC</sub>	4.9	°C/W

#### ■ ELECTRICAL CHARACTERISTICS (T<sub>c</sub>=25°C, unless otherwise specified)

		1						
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	500			V	
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =500V, V <sub>GS</sub> =0V			1	μA	
Gate- Source Leakage Current	Forward		V <sub>GS</sub> =+30V, V <sub>DS</sub> =0V			+100	nA	
	Reverse		V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA	2.0		4.0	V	
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =1.5A		2.2	3.2	Ω	
DYNAMIC PARAMETERS								
Input Capacitance		CISS			280	365	рF	
Output Capacitance		Coss	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0MHz		50	65	рF	
Reverse Transfer Capacitance		C <sub>RSS</sub>			8.5	11	рF	



## ELECTRICAL CHARACTERISTICS(Cont.)

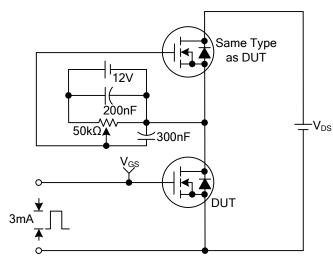
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT			
SWITCHING PARAMETERS									
Total Gate Charge	$Q_{G}$			10	13	nC			
Gate to Source Charge	$Q_{GS}$	V <sub>GS</sub> =10V, V <sub>DS</sub> =400V, I <sub>D</sub> =3A (Note 1, 2)		1.5		nC			
Gate to Drain Charge	$Q_{GD}$	(Note 1, 2)		5.5		nC			
Turn-ON Delay Time	t <sub>D(ON)</sub>	V <sub>DD</sub> =250V, I <sub>D</sub> =3A, R <sub>G</sub> =25Ω (Note 1, 2)		10	30	ns			
Rise Time	t <sub>R</sub>			25	60	ns			
Turn-OFF Delay Time	t <sub>D(OFF)</sub>			35	80	ns			
Fall-Time	t <sub>F</sub>			25	60	ns			
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS									
Maximum Body-Diode Continuous Current	ls				3	Α			
Maximum Body-Diode Pulsed Current	I <sub>SM</sub>				12	Α			
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =3A, V <sub>GS</sub> =0V			1.4	V			
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>S</sub> =3A, V <sub>GS</sub> =0V,		170		ns			
Body Diode Reverse Recovery Charge	$Q_RR$	dl <sub>F</sub> /dt=100A/µs (Note 1)		0.7		μC			

Notes: 1. Pulse Test: Pulse width  $\leq$  300µs, Duty cycle  $\leq$  2%

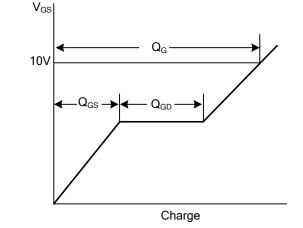
2. Essentially independent of operating temperature



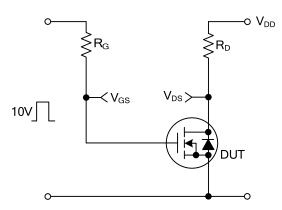
#### TEST CIRCUITS AND WAVEFORMS



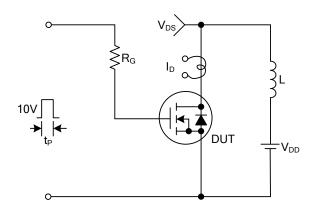
**Gate Charge Test Circuit** 



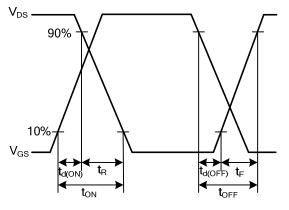
**Gate Charge Waveforms** 



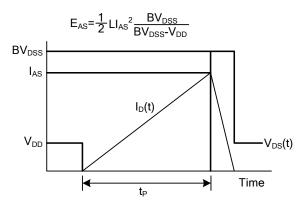
**Resistive Switching Test Circuit** 



**Unclamped Inductive Switching Test Circuit** 



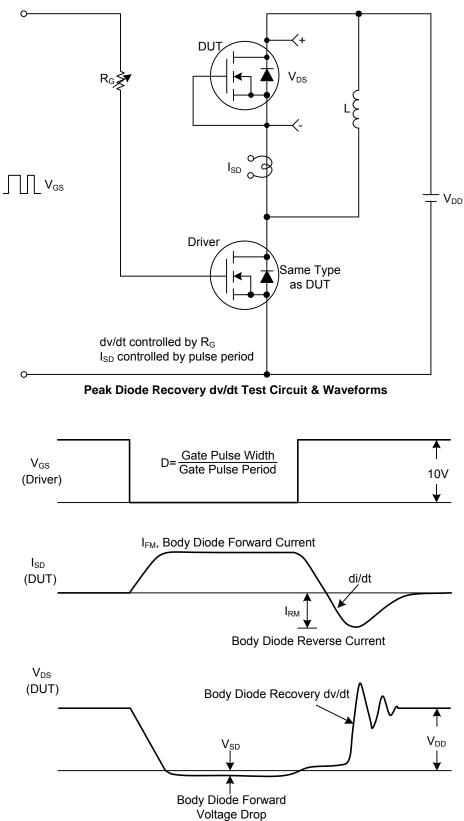
**Resistive Switching Waveforms** 



**Unclamped Inductive Switching Waveforms** 



### ■ TEST CIRCUITS AND WAVEFORMS(Cont.)





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